

R.V. COLLEGE OF ENGINEERING (Autonomous Institution Affiliated to VTU, Belagavi) R.V. Vidyaniketan Post, Mysore Road Bengaluru – 560 059



Bachelor of Engineering (B.E.) Scheme and Syllabus for VII & VIII Semesters

2016 SCHEME

ELECTRONICS & COMMUNICATION ENGINEERING

Department Vision

Imparting quality technical education through interdisciplinary research, innovation and teamwork for developing inclusive & sustainable technology in the area of Electronics and Communication Engineering.

Department Mission

- To impart quality technical education to produce industry-ready engineers with a research outlook.
- To train the Electronics & Communication Engineering graduates to meet future global challenges by inculcating a quest for modern technologies in the emerging areas.
- To create centres of excellence in the field of Electronics & Communication Engineering with industrial and university collaborations.
- To develop entrepreneurial skills among the graduates to create new employment opportunities.

PROGRAM EDUCATIONAL OBJECTIVES (PEOs)

- **PEO1.** To apply concepts of mathematics, science and computing to Electronics and Communication Engineering
- **PEO2.** To design and develop interdisciplinary and innovative systems.
- **PEO3.** To inculcate effective communication skills, team work, ethics, leadership in preparation for a successful career in industry and R & D organizations.

PSO	Description
PSO1	Should be able to clearly understand the concepts and applications in the field of Communication/networking, signal processing, embedded systems and semiconductor technology.
PSO2	Should be able to associate the learning from the courses related to Microelectronics, Signal processing, Microcomputers, Embedded and Communication Systems to arrive at solutions to real world problems.
PSO3	Should have the capability to comprehend the technological advancements in the usage of modern design tools to analyze and design subsystems/processes for a variety of applications.
PSO4	Should possess the skills to communicate in both oral and written forms, the work already done and the future plans with necessary road maps, demonstrating the practice of professional ethics and the concerns for societal and environmental wellbeing.

PROGRAM SPECIFIC OUTCOMES (PSOs)

Lead Society: Institute of Electrical and Electronics Engineers (IEEE)

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ABBREVIA	TIONS
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Sl. No.	Abbreviation	Meaning		
1.	VTU	Visvesvaraya Technological University		
2.	BS	Basic Sciences		
3.	CIE	Continuous Internal Evaluation		
4.	SEE	Semester End Examination		
5.	CE	Professional Core Elective		
6.	GE	Global Elective		
7.	HSS	Humanities and Social Sciences		
8.	CV	Civil Engineering		
9.	ME	Mechanical Engineering		
10.	EE	Electrical & Electronics Engineering		
11.	EC	Electronics & Communication Engineering		
12.	IM	Industrial Engineering & Management		
13.	EI	Electronics & Instrumentation Engineering		
14.	СН	Chemical Engineering		
15.	CS	Computer Science & Engineering		
16.	TE	Telecommunication Engineering		
17.	IS	Information Science & Engineering		
18.	BT	Biotechnology		
19.	AS	Aerospace Engineering		
20.	PH	Physics		
21.	СН	Chemistry		
22.	MA	Mathematics		

RV COLLEGE OF ENGINEERING® (Autonomous Institution Affiliated to VTU, Belagavi) ELECTRONICS AND COMMUNICATION ENGINEERING

	SEVENTH SEMESTER CREDIT SCHEME							
C1	Course				Credit Allo	ocation		Total
SI. No	Course Code	Course Title	BOS	Lectur e	Tutorial	Practica l	SS	Credit s
1	16EC71	Microwave & Radiating Systems	EC	4	0	1	0	5
2	16EC72	Broadband Wireless –LTE 4G	EC	4	0	0	0	4
3	16EC73	Minor Project**	EC	0	0	3	0	3
4	16EC7FX	Elective F (PE)	EC	4	0	0	0	4
5	16EC7GX	Elective G(PE)	EC	4	0	0	0	4
6	16G7HXX	Elective H (OE)*	Respe ctive BOS	3	0	0	0	3
	Total No. of Credits							23
	No. Of Hrs.			19	0	8	0	27

** EI, EE, CV, EC, ME – 6 hrs. / week Minor Project. *Students should take other department Global Elective courses

	VII Semester					
	GROUP F: PROFESSIONAL ELECTIVES					
Sl. No.	Course Code	Course Title				
1.	16EC7F1	Satellite Communications & GPS				
2.	2. 16EC7F2 ARM Programming & Optimization					
3.	3. 16EC7F3 Speech Processing					
4.	4. 16EC7F4 Radio Frequency Integrated Circuits Design					
5. 16EC7F5 High Performance Computing						
6.	16EC7F6	Integrated Photonics				
7.	16EC7F7	Vanoelectronics				
		VII Semester				
	Gl	ROUP G: PROFESSIONAL ELECTIVES				
Sl. No.	Course Code	Course Title				
1.	16EC7G1	Radar & Navigation				
2.	16EC7G2	Automotive Electronics				
3.	16EC7G3	Multimedia Communication				
4.	16EC7G4	VLSI Testing for ICs				
5.	16EC7G5	High Speed digital design				
6.	16EC7G6	MEMS and Smart Systems				

R.V. College	e of Enginee	ering – Ben	galuru-59

Sl. No.	Host Dept	Course Code	Course Title
1.	BT	16G7H01	Nanotechnology
2.	СН	16G7H02	Industrial Safety and Risk Management
3.	CV	16G7H03	Intelligent Transport System
4.	CS	16G7H04	Intelligent System
5.	EC	16G7H05	Image Processing and Machine Learning
6.	EE	16G7H06	Design of Renewable Energy Systems
7.	IM	16G7H07	Systems Engineering
8.	EI	16G7H08	MEMS and Application
9.	IS	16G7H9	Introduction to Internet of Things
10.	ME	16G7H10	Industry 4.0 – Smart Manufacturing for The Future
11.	TC	16G7H11	Space Technology and Application
12.	MA	16G7H12	Advanced linear Algebra
13.	PY	16G7H13	Thin Film Nanotechnology
14.	CY	16G7H14	Engineering Material for Advance Technology
15.	HSS	16G7H15	Applied Psychology for Engineers
16.	HSS	16G7H16	Foundational Course on Entrepreneurship
17.	AS	16G7H17	Unmanned Aerial Vehicles

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	EIGTH SEMESTER CREDIT SCHEME							
SI.	Sl. Course a mu			Credit Allocation				Total
No.	Code	Course Title	BOS	Lecture	Tutorial	Practical	SS	Credits
1.	16EC81	Major Project	EC	0	0	16	0	16
2.	16EC82	Technical Seminar	EC	0	0	2	0	2
3.	16HS83	Innovation and Social Skills	HSS	0	0	2	0	2
	Total No. of Credits							20
	No. Of Hrs.			0	0	40	0	40

Credit Allocation for 2016 Scheme Semester Wise

Sl.No	Semester	Credits	
1	Ι	25	
2	II	25	
3	III	25	
4	IV	25	
5	V	29	
6	VI	28	
7	VII	23	
8	VII	20	
	TOTAL		

Microwave & Radiating Systems Course Code : 16EC71 CIE : 100+50 Course Code : 16EC71 CIE : 100+50			
Credits: L:T:P:S : 4:0:1:0 SEE : 100+50			
Total Hours:46LSEE Duration:3Hrs+3Hrs			
Course Learning Objectives: The students will be able to			
1 Apply the knowledge of fields and waves to develop concepts of transmission line theory.			
2 Describe the basic operation of microwave devices.			
3 Describe the radiation from isolated, linear wire antennas and from linear elements near or or			
a conducting surface.4 Calculate the fundamental parameters for antennas and the radiation field from an antenna			
using potential functions.			
Unit-I 09 Hrs			
Transmission Lines : Introduction, transmission lines equations and solutions, termination of line			
by infinite line, by characteristic impedance, short circuit line, open circuit line and any load resistive			
impedance ,input impedance reflection and transmission coefficients, standing waves and SWR(a			
both load end and generator end).			
Unit – II 09 Hrs			
Impedance Transforms and Matching: Quarter wave transforms, Smith chart construction and			
properties, Single stub matching.			
Microwave Waveguides: Introduction, TE, TM waves Rectangular waveguides (quantitative			
analysis TE, TM modes), circular waveguides (quantitative analysis), dominant modes, group			
velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonan			
frequency.			
S-parameters: Introduction, properties of S matrix (qualitative analysis)			
Unit –III 09 Hrs			
Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider			
Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s			
parameters of all devices)			
Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator			
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- 3. Design and Simulation of a Printed Hybrid Ring.
- 4. Design and Simulation of Patch Antenna, Dipole and Analysis of Antenna Arrays.
- 5. Characterization of Microwave E-plane, H-plane and Magic Tee
- 6. Characterization of Directional Coupler, Circulator, Attenuator and Isolator.
- 7. Radiation characteristics of Microstrip Patch and Printed Dipole Antenna
- 8. Radiation Characteristics of Pyramidal Horn Antenna
- 9. Performance Analysis of Rayleigh and Rician Fading Channel Models using Matlab
- 10. Generation and Reception of Gold sequence, Direct Sequence Spread Spectrum in Matlab
- 11. Demo: Design and Simulation of a Power divider.
- 12. Demo: Characterization of Microwave devices with Network analyzer

Course	e Outcomes: After completing the course, the students will be able to
CO1:	Explain and summarize the working of transmission line, Waveguides, Microwave Passive
	Devices and Antennas
CO2:	Analyze wave propagation in transmission line, Waveguides and characterize the passive
	microwave components and Antennas.
CO3:	Design the transmission lines, passive microwave components and Antennas for given
	specification and also match the impedance.
CO4:	Evaluate S-Parameter, VSWR for transmission lines, Microwave components and radiation
	pattern for Antennas.

Refere	ence Books
1	David M Pozar, "Microwave Engineering", John Wiley, 3rd Edition, 2004, ISBN-13: 978-
1	0471644514
2	C A Balanis, "Antenna Theory and Design", John Wiley & sons, Inc. publication, 3rd
2	Edition,2005,ISBN-13: 978-0471667827
3	National Instruments, ' Basics of Power Amplifier and Front End Module Measurements'
5	White paper, http://www.ni.com/rf/
4	R E Collin, "Foundations of Microwave Engineering", IEEE Press on Electromagnetic and
-	Wave Theory, 2 nd Edition, ISBN-13: 978-0-7803-6031-0/ 0-7803-6031-1
5	John D.Krauss, "Antennas", McGraw-Hill International Edition, 3rd Edition, 2006.ISBN-
5	13: 978-0071232012

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

Laboratory- 50 Marks

The Laboratory session is held every week as per the time table and the performance of the student is evaluated in every session. The average of marks over number of weeks is considered for 40 marks. At the end of the semester a test is conducted for 10 marks. Total marks for the laboratory is 50.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I,

IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

Laboratory- 50 Marks

Experiment Conduction with proper results is evaluated for 40 marks and Viva is for 10 marks. Total SEE for laboratory is 50 marks.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	0	0	0	0	2	0	0	2	0	1
CO2	3	2	2	1	0	0	2	0	0	2	0	1
CO3	3	3	2	2	0	0	2	0	0	2	0	1
CO4	3	3	3	3	0	0	2	0	0	2	0	1

				Semester: VII			
Broadband Wireless -LTE 4G							
Сош	rse Code	:	16EC72		CIE	:	100 Marks
	lits: L:T:P:S	:			SEE	:	100 Marks
	l Hours	:			SEE Duration	:	03 Hours
		Dbj	ectives: The studen				
1				tical characterization t	for them.		
2				l call processing as we		d ser	vices.
3				lications of spread			
	Synchronizat	ion	•	_	_		_
4	Identify phys	ical	l layer and call proc	essing protocols for c	ellular CDMA.		
				U nit-I			09 Hrs
	ew of Legacy	-					
•				, Single carrier FDMA	•		
				g, Multiantenna Techr	iques, IP based F	lat no	etwork
			twork Architecture.		a sharral (DWC)	East	ling in DWC
				ot, Broadband wireles cal models, Mitigatio			•
Fadi		ЕП	ipirical and Statisti	cal models, Miligano	on thantow bar	iu ai	
Faun	lg		T	nit – II			09 Hrs
Mult	ticarrier Mo	dul		asics, OFDM in	LTE, Timing a	and	Frequency
	hronization, P.				212, 111111g		requeiley
				DMA, TDMA, CDM	A, OFDMA, SC-F	DM	A, OFDMA
and S	SC-FDMA in I	LTE	2				
Mult	tiple Antenna	Tr	ansmission and R	eception: Spatial Div	ersity overview, l	Rece	ive Diversity,
				ion and signal enhance		ltipl	exing, Choice
betw	een Diversity,	Inte	erference suppression	on and Spatial Multipl	exing		
			-	nit —III			09 Hrs
Overview and Channel Structure of LTE: Introduction to LTE, Channel Structure of LTE,							
				nk SC-FDMA Radio			
	-			sing: Overview, Dov			
		Bro	adcast channels, Mi	ulticast channels, Dow	nlink physical cha	anne	ls, H-ARQ on
Downlink Unit –IV 10 Hrs							
T] 12.	als Channel /	T			shound shounds	T Lee	10 Hrs
-				: Overview, Uplink			link Control
				undom Access Channe RQ procedures, Chan			OI feedback
				ons, Uplink channel s			
			· ·	ation, Cell Search, R	•		
-	rol in uplink.	an	a Resource Anoca	ation, cen Searen, N	andoni Access i	TOCC	dures, rower
Cont	ioi in upinik.		T	nit –V			09 Hrs
Radi	o Resource M	an		ility Management:			57 1115
			8	v, RRC overview,	Mobility Manag	eme	nt, Inter-cell
	ference Coordi			, s.e., .e.,		,	.,

Course Outcomes: After completing the course, the students will be able to

CO1:	Associate terms in the system architecture to the functional standard specified in LTE 4G.
CO2:	Analyze the role of LTE radio interface protocols and EPS Data convergence protocols to
	set up, reconfigure and release data and voice from users.
CO3:	Demonstrate the UTRAN and EPS handling processes from set up to release including
	mobility management for a variety of data call scenarios.
CO4:	Test and Evaluate the Performance of resource management and packet data processing
	and transport algorithms.

Reference Books							
1	Arunabha Ghosh, Jan Zhang, Jefferey Andrews, Riaz Mohammed, 'Fundamentals of LTE', Prentice Hall, Communications Engg and Emerging Technologies.						
I	Prentice Hall, Communications Engg and Emerging Technologies.						
2	Harri Holma and Antti Toskala, 'LTE for UMTS Evolution to LTE-Advanced', Second						
2	Edition - 2011, John Wiley & Sons, Ltd. Print ISBN: 9780470660003.						

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Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	0	0	0	0	2	0	0	2	0	3
CO2	3	2	2	1	0	0	2	0	0	2	0	3
CO3	3	3	2	2	0	0	2	0	0	2	0	3
CO4	3	3	3	3	0	0	2	0	0	2	0	3

	VII Semester							
	Mini Project							
Course Code: 16EC73		CIE Marks: 100						
Credits: L: T: P: S:: 0:0:3:0		SEE Marks: 100						
Hrs/v	week: 06	SEE Duration: 3 Hrs						
Cour	Course Learning Objectives: The students will be able to							
1	Create interest in innovative developments and preferably interdisciplinary field.							
2	Work independently, analyze, evaluate and solve the given problem.							
3	Inculcate the skills for good presentation and improve the technical report writing skills.							
4	Recognize the need for planning, preparation, management and financial budgeting.							
5	Acquire collaborative skills through working in a team to achieve common goals.							

Mini Project Guidelines:

- 1. Each project group will have two to four students, they can form their groups amongst their class.
- 2. Each group has to select a current topic that will use the technical knowledge of their program of study after intensive literature survey.
- 3. Guides will be allotted by the department based on the topic chosen.
- 4. The project should result in system/module which can be demonstrated, using the available resources in the college.
- 5. The CIE evaluation will be done by the committee constituted by the department. The committee shall consist of respective guide & two senior faculty members as examiners. The evaluation will be done for each student separately.
- 6. The final copy of the report should be submitted after incorporation of any modifications suggested by the evaluation committee

Guidelines for Evaluation:

CIE Assessment:

Evaluation will be carried out in three phases:

Phase	Activity	Weightage
Ι	Synopsis submission, approval of the selected topic, formulation of objectives	20%
II	Mid-term evaluation to review the progress of work and documentation	30%
III	Submission of report, Final presentation and demonstration	50%

The following are the weightages given for the various stages of the project:

- 1. Selection of the topic and formulation of objectives: 10%
- 2. Design and Development of Project methodology: 30%
- 3. Execution of Project: 30%
- 4. Presentation, Demonstration and Discussion: 20%
- 5. Report Writing:10%

SEE Assessment:

The following are the weightages given during SEE Examination:

1. Written presentation of synopsis:10%

- 2. Presentation/Demonstration of the project: 30%
- Methodology and Discussion: 30%
 Technical Report: 10%
 Viva Voce: 20%

Cour	Course Outcomes of Mini Project:					
1	Define Specifications, Conceptualize, Design and implement a project					
2	Communicate the work carried out as a technical report and orally					
3	Work in a team and contribute to team work					
4	Indulge in self-learning and be motivated for life-long learning					

	Semester: VII							
	SATELLITE COMMUNICATIONS & GPS							
			(Group F: P	Professional Core E	lective)			
	(Theory)							
Cou	rse Code	:	16EC7F1		CIE	:	100 Marks	
Cred	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks	
Tota	Total Hours		50L		SEE Duration	:	03 Hours	
Cou	rse Learning (Dbj	ectives: The studen	ts will be able to				
1	Understand th	ne S	Satellite orbits and o	rbital perturbations.				
2	2 Analyze link power budget calculations and losses in the atmosphere.							
3	3 Understand the components of the satellite in space and Earth stations							
4	4 Analyze Fixed Coordinate System and GPS C/A Code Signal Structure							

Unit-I	10 Hrs				
Over View of Satellite Systems: Introduction, frequency allocation, Kepler laws, definition	ns, orbital				
element, apogee and perigee heights, orbit perturbations, inclined orbits, calendars, univer	rsal time,				
sidereal time, orbital plane, local mean time and sun synchronous orbits, Geostationa	-				
Introduction, antenna, look angles, polar mix antenna, limits of visibility, earth eclipse of	satellite,				
sun transit outage.					
Unit – II	10 Hrs				
Propagation Impairments and Space Link: Introduction, atmospheric loss, ionospheri					
rain attenuation, other impairments. Space Link: Introduction, EIRP, transmission losses, li	nk power				
budget, system noise, CNR, uplink, down link, effects of rain, combined CNR.					
Unit –III	10 Hrs				
Space Segment: Introduction, power supply units, altitude control, station keeping, therma					
TT&C, transponders, antenna subsystem. Earth Segment: Introduction, receive only h	nome TV				
system, outdoor unit, indoor unit, MATV, CATV, Tx – Rx earth station					
Unit –IV	10 Hrs				
GPS: Introduction, History of GPS Development, A Basic GPS Receiver, Appro	aches of				
Presentation, Software Approach, Potential Advantages of the Software Approach. Basic GPS					
Concept: Introduction, GPS Performance Requirements, Basic GPS Concept, Basic Equations for					
Finding User Position, Measurement of Pseudo-range, Solution of User Position from Pseud	•				
Position Solution with more than Four Satellites, User Position in Spherical Coordinate Syste					
Geometry, Basic Relationships in an Ellipse, Calculation of Altitude, Calculation of					
Latitude, Calculation of a Point on the Surface of the Earth, Satellite Selection, Dilution of I					
Satellite Constellation: Introduction, Control Segment of the GPS System, Satellite Const					
Maximum Differential Power Level from Different Satellites, Sidereal Day, Doppler F					
Shift, Average Rate of Change of the Doppler Frequency, Maximum Rate of Change of the					
Frequency, Rate of Change of the Doppler Frequency Due to User Acceleration, Kepler's	Equation,				
True and Mean Anomaly, Signal Strength at User Location.	10.77				
Unit –V	10 Hrs				
Earth-Centered, Earth-Fixed Coordinate System : Introduction, Direction Cosine					
Satellite Orbit Frame to Equator Frame Transform, Vernal Equinox, Earth Rotation,					
Transform from Orbit Frame to Earth-Centered, Earth-Fixed Frame, Perturbations, Corr					
GPS System Time of Transmission, Calculation of Satellite Position, Coordinate Adjust					
Satellites, Ephemeris Data.: GPS C/A Code Signal Structure: Introduction, Tra	•				
Frequency, Code Division-Multiple Access (CDMA) Signals, P Code, C/A Code and Data					
Generation of C/A Code, Correlation Properties of C/A Code, Navigation Data Bits, T	•				
(TLM) and Hand Over Word (HOW), GPS Time and the Satellite Z Count, Parity Check A	÷				
Navigation Data from sub frame 1, Navigation Data from subframes 2 and 3, Navigation I subframes 4 and 5–Support Data, Ionospheric Model, Tropospheric Model, Selectivity Av	Jata Irom				

Course	Course Outcomes: After completing the course, the students will be able to						
CO1:	Analyse the basic concepts of orbital mechanics of satellites and GPS						
CO2:	Apply the basic concepts to solve problems in satellites and GPS						
CO3:	Analyze various transmission losses and components of space & Earth Segment						
CO4:	Evaluate noise effect and Signal Structure of Satellite and GPS.						

Reference Books

1	Dennis Roddy, "Satellite Communications", McGraw-Hill, 4th Edition, 2006, ISBN 0-07-146298-8
2	Timothy Pratt, Charles Bostian and Jeremy Allnutt, "Satellite Communications", John Wiley & Sons, 2 nd Edition, 2003, ISBN: 978-0-471-37007-9
3	James Bao-Yen, Tsui, "Fundamentals of Global Positioning System Receivers: A Software Approach", John Wiley, 2 nd Edition , 2005, ISBN: 978-0-471-70647-2
4	K. N. Raja Rao, "Fundamentals of Satellite Communication", PHI Learning Pvt. Ltd, 2 nd Edition, ISBN, 8120324013

Continuous Internal Evaluation (CIE); Theory (100 Marks)

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Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

					CO-l	PO Ma	pping					
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	2	2	-	-	-	-	-	1	-	1
CO2	3	3	2	1	-	-	-	-	-	1	-	1
CO3	3	1	2	1	-	-	-	-	-	1	-	1
CO4	3	2	2	1	-	-	-	-	-	1	-	1

Low-1 Medium-2 High-3

				Semester: VII					
	ARM PROGRAMMING & OPTIMIZATION								
	(Group F: Professional Core Elective)								
			1	(Theory)					
	rse Code	:	16EC7F2		CIE	:	100 Marks		
	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks		
	l Hours	:	50L		SEE Duration	:	03 Hours		
Cou			ectives: The studen						
1	Discuss the b	asic	c principles of ARM	l system design.					
2				ents ARM data path					
3				d embedded system v	vith the basic knowl	edge	e of firmware,		
	embedded OS	5&	ARM architectures						
4	•			tions/program know	ing the basic prin	ncip	les of ARM		
			assembly language.						
5	Compare prog	grai	ns written in C & as	ssembly to execute o	n ARM platform.				
				J nit-I			10 Hrs		
				egisters, Modes, Ex	-				
				s, Load store instruc					
· ·				ading constants, AI					
				egister usage, ARM		-			
	-		2	ingle register load sto		tiple	e register load		
store	instructions, st	tack		are interrupt instruct	ion.				
				nit — II			10 Hrs		
				v of C Compilers and					
				nction calls, pointer					
fields	s, unaligned Da	ata	and Endianess, divi	sion, floating point,	inline functions and	l inl	ine assembly,		
monto	n antah ilitar iaanaa								

portability issues.	
Unit –III	10 Hrs
Writing and Optimizing ARM Assembly Code: Writing assembly code, profiling a	and cycle
counting, instruction scheduling, register allocation, conditional execution, looping const	ructs, Bit
manipulation, efficient switches. Handling unaligned data	
Unit –IV	10 Hrs
Digital Signal Processing on ARM: Representing a digital signal, Introduction to DSP on t	he ARM,
FIR filters, Realization of filters on ARM7 and Cortex M3, IIR Filters, Realization of	filters on
ARM7 and Cortex M3, CMSIS DSP Library	

Unit –V10 HrsException and Interrupt Handling Exception Handling, Interrupts, Non-nested Interrupt handler,
Re-entrant Interrupt handler Firmware & Boot loader Embedded Operating Systems Fundamental
Components, Simple Operating System

Course	e Outcomes: After completing the course, the students will be able to
CO1:	Describe the programmer's model of ARM processor and analyse the instruction set
	architecture to realize complex operations.
CO2:	Apply the optimization methods available for ARM architectures to design embedded
	software to meet given constraints with the help of modern engineering tools.
CO3:	Realize real time signal processing applications & primitive OS operations on different ARM
	architectures by making use of software libraries.
CO4:	Engage in self-study to formulate, design, implement, analyze and demonstrate an
	application realized on ARM development boards through assignments.

Refere	ence Books
1	Andrew N Sloss, Dominic Symes, Chris Wright, "ARM System Developers Guide",
	Elsevier, Morgan Kaufman publishers, 2008, ISBN-13:9788181476463
2	David seal, "ARM Architecture Reference Manual", Addison-Wesley, 2 nd Edition, 2009,
2	ISBN-13:9780201737196
2	Steve Furber, "ARM System on Chip Architecture", Pearson Education Limited, 2 nd Edition,
3	ISBN-13:9780201675191
4	Technical reference manual for ARM processor cores, including Cortex, ARM 11, ARM 9
4	& ARM 7 processor families.
5	User guides and reference manuals for ARM software development and modeling tools.

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Semester End Evaluation (SEE); Theory (100 Marks)

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					CO-I	PO Ma	pping					
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	2	3									
CO2	3	2	2	3				2	2			
CO3	2	2	3	3				2	2			
CO4	3	3	3	3	2	3	2	3	3	3	2	3

				Semester: VII					
			SPE	CH PROCESSING	r I				
	(Group F: Professional Core Elective)								
				(Theory)					
Cou	rse Code	:	16EC7F3		CIE	:	100 Marks		
Cred	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks		
	Fotal Hours:50LSEE Duration:03 Hours								
		~	ectives: The studer						
1	<u>^</u>			scientific, and comp	outational skills rele	vant	to the field of		
	biomedical si								
2			•	ormulating problem	is and designing	analy	sis tools for		
2	biological sig			6 (1 1	· · · · · · · · · · · · · · · · · · ·	11.			
3				f the complexity of	various biologica	n pu	enomena and		
4			erstanding of the sau	d teamwork commu	nication				
7		v C I	interaction skins all		invation				
	I						10 Hrs		
			I	U nit-I					
Intro	oduction to d	igit	al speech signal	processing: Digitiza	ation and recordin	g, H	luman speech		
				e and manner at ar					
phon	etics, Uniform	tub		ch processing, Huma	n auditory system, S	Spee	ch perception.		
				nit – II			10 Hrs		
				sing: Time dependen					
	•	-		ence discrimination	ē ē.		• •		
				g approach, short tim					
avera	age magnitude	d111		tch period estimation	n using autocorrelat	10n İ			
Show	t Time Fou			nit –III	and monortica	Form	10 Hrs		
				uction, Definitions					
-			U	n, Sampling rates of thesis, Spectrograph		1 ITe	quency, Filter		
Ualik	summation m	Jun		nit –IV	ic displays.		10 Hrs		
Feat	ure extractio	n:		ndamental frequenc	y Frequency dor	nain			
				and supra segment					
-	•			on, Mel-frequency			-		
vecto		1100	purumeters entraet	ion, mer nequency	copsilui coomoron	, 101			
			U	nit –V			10 Hrs		
Spee	ch based Ap	olic		ech synthesis, Auto	matic speech reco	gniti			
				, and Speech based to					
	<u> </u>			*	1		0		
Cou	rse Outcomes:	Af	ter completing the	course, the studen	ts will be able to				
CO1				ng techniques in bio					
CO2				fic and computation		o ana	alyze		
	biomedical	<u> </u>		_		<u> </u>			
CO3	Formulate	and	l solve basic proble	ms in biomedical sig	gnal analysis.				

CO4: Design of Signal processing algorithm to be used in DSP Processor

Reference Books

1	L R Rabiner and R W Schafer, "Digital Processing of Speech Signals", Pearson Education
1	2004. ISBN: 0-13-213603-1
	Sadoaki Furui, "Digital Speech Processing, Synthesis and Recognition", Second
2	Edition,Mercel Dekk er 2002. ISBN-13: 978-0824704520
	Rabiner and B.Juang,"Fundamentals of Speech Recognition," Pearson Education, 2004,
3	ISBN-13: 978-0130151575
	Thomas F. Quatieri,"Discrete-Time Speech Signal Processing: Principles and Practice",
4	Prentice Hall; 1 edition (10 November 2008),ISBN:0-13-242942-X
-	L. R. Rabiner and R. W. Schafer, "Theory and Applications of Digital Speech Processing",
5	Pearson; 1 edition (3 March 2010), ISBN: 978-0136034285

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CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	2	1	3	2	1	2	2	3	3	3
CO2	3	3	3	2	3	1	1	1	3	1	3	3
CO3	3	3	3	2	3	1	1	1	2	1	3	3
CO4	3	3	3	3	2	1	1	1	2	1	3	3

			Semester: VII			
		Radio Fre	quency Integrated C	ircuits Design		
Course Code	:	16EC7F4		CIE	:	100 Marks
Credits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks
Total Hours	:	50L		SEE Duration	:	03 Hours
Course Learning	Obj	ectives: The st	tudents will be able to			
1 Define and	lemo	onstrate the im	portance of radio freq	uency design.		
2 Analyze the	func	ctionality and d	lesign issues of RF cir	rcuits and systems.		
3 Design and	impl	ement RF trans	sceiver.			
4 Evaluate the	diff	erent performation	ince parameters used i	in RF design.		
			Unit-I			10 Hrs
Introduction to R	F De	esign and Wir	eless Technology - va	arious disciplines in RF	⁷ desi	gn, RF design
hexagon.						
-		0	5	linearity and Time V		
				dB compression poi		
		ation, intermod	lulation – third interce	ept point, cascaded nor	nlinea	ar stages – IM
spectra in a cascad	le.					10.77
			Unit – II			10 Hrs
Noice in DF einen	40					
		·		input referred noise, I		•
figure of cascaded	l stag	ges, Noise figu		- input referred noise, l ensitivity, dynamic rar		•
figure of cascaded dynamic range (SI	l stag FDR)	ges, Noise figu).	re of lossy circuits, So	ensitivity, dynamic rar	nge –	spurious free
figure of cascaded dynamic range (SI Transceiver arch	l stag FDR) itect	ges, Noise figu). z ures – channe	re of lossy circuits, Solar selection and band s	ensitivity, dynamic rai selection, Heterodyne	nge – – coi	spurious free
figure of cascaded dynamic range (SI Transceiver arch constant IF down	l stag FDR) itect iconv	ges, Noise figu). z ures – channe version, proble	re of lossy circuits, Selection and band sem of image, image	ensitivity, dynamic ran selection, Heterodyne rejection vs channel	nge – – coi selec	spurious free stant LO and stion, dual IF
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody	l stag FDR) itect iconv yne –	ges, Noise figu). z ures – channe version, proble - simple homo	re of lossy circuits, Selection and band sem of image, image dyne and homodyne	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down	nge – – con selec conv	spurious free nstant LO and ction, dual IF version, issues
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece	l stag FDR) itect conv yne – ivers	ges, Noise figu). z ures – channe version, proble - simple homo s, Image Rejec	re of lossy circuits, Se I selection and band se em of image, image dyne and homodyne t – Hartley & Weaver	ensitivity, dynamic ran selection, Heterodyne rejection vs channel	nge – – con selec conv	spurious free nstant LO and ction, dual IF version, issues
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody	l stag FDR) itect conv yne – ivers	ges, Noise figu). z ures – channe version, proble - simple homo s, Image Rejec	re of lossy circuits, Se I selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters.	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down	nge – – con selec conv	spurious free nstant LO and ction, dual IF version, issues architectures -
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion	l stag FDR) itect iconv yne – ivers and t	ges, Noise figu J. ures – channe Version, proble - simple homo s, Image Rejec two-step transi	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi	nge – con selec conv itter a	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedance	l stag FDR) itect iconv yne – ivers and t	ges, Noise figu). cures – channe version, proble - simple homo s, Image Rejec two-step transi ansformation	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III – Quality factor, seri	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversion	nge – con selec conv itter a	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedance	l stag FDR) itect iconv yne – ivers and t	ges, Noise figu). cures – channe version, proble - simple homo s, Image Rejec two-step transi ansformation	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversion	nge – con selec conv itter a	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedane networks- L, T, Pi	I stag FDR) itect iconv yne – ivers and t ce tra -mat	ges, Noise figu). pures – channe version, proble - simple homo s, Image Rejec two-step transp ansformation ch networks, ta	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III – Quality factor, seri apped inductor and ca	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversion pacitor networks	nge – con selec conv itter a	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs asic matching
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece <u>Direct conversion</u> Passive impedane networks- L, T, Pi Low noise Ampli	I stag FDR) itect iconv yne – ivers and t ce tra -mat	ges, Noise figu). ures – channe version, proble - simple homo s, Image Rejec two-step transp ansformation ch networks, ta	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III – Quality factor, seri- apped inductor and ca parameters, Problem o	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversion pacitor networks f Input matching, CS s	nge – con selec conv itter a on, b	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs asic matching with inductive
figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedano networks- L, T, Pi Low noise Ampli load, Cascode C	I stag FDR) itect iconv yne – ivers and t ce tra -mat	ges, Noise figu). ures – channe version, proble - simple homo s, Image Rejec two-step transp ansformation ch networks, ta	re of lossy circuits, Se el selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III – Quality factor, seri- apped inductor and ca parameters, Problem o	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversion pacitor networks	nge – con selec conv itter a on, b	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs asic matching with inductive
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figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedane networks- L, T, Pi Low noise Ampli load, Cascode C calculation.	I stagg FDR) itect iconv yne – ivers and t ce tra- ce tra- fier - S sta	ges, Noise figu). Jures – channe version, proble - simple homo s, Image Rejec two-step transp two-step transp ansformation ch networks, ta Performance p age with indu	re of lossy circuits, Se I selection and band se em of image, image dyne and homodyne t – Hartley & Weaven mitters. Unit –III – Quality factor, seri- apped inductor and ca parameters, Problem of active degeneration (Unit –IV	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversi- pacitor networks of Input matching, CS s (MOSFET circuits on	nge – con selec conv itter a on, b tage nly),	spurious free nstant LO and ction, dual IF version, issues architectures - 10 Hrs asic matching with inductive Noise figure 10 Hrs
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figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedane networks- L, T, Pi Low noise Ampli load, Cascode C calculation. Mixer - Performa and passive) – wo Oscillators - Pe coupled oscillator, Phase Locked Lo Drawbacks of sin	I stagg FDR) itect iconv ivers and t ce tra- ce tra- mate fier - S sta nce p rking rforn thre pops nple	ges, Noise figu). pures – channe version, proble - simple homo s, Image Rejec two-step transp ansformation ch networks, ta Performance p age with indu parameters, Mi g (MOSFET ci nance parameter e point oscillar - Basic conce	re of lossy circuits, Se I selection and band se am of image, image dyne and homodyne of t – Hartley & Weaven mitters. Unit –III – Quality factor, seri- apped inductor and ca barameters, Problem of active degeneration (Unit –IV xer noise figures, sing- reuits only) ters, Feedback view tors, (MOSFET circui- Unit –V pts - Phase detector, I PLLs - PFD, char-	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversi- pacitor networks of Input matching, CS s (MOSFET circuits on gle balanced and doub and one port view of ts only), Ring oscillato Type I PLL, Dynami	nge – conv itter a on, b tage f nly), le ba coscions. cs of mp I	spurious free nstant LO and ction, dual IF version, issues architectures 10 Hrs asic matching with inductive Noise figure 10 Hrs lanced (active illators, Cross 10 Hrs f simple PLL PLL, PFD/CF
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figure of cascaded dynamic range (SI Transceiver arch constant IF down topology, Homody in homodyne rece Direct conversion Passive impedane networks- L, T, Pi Low noise Ampli load, Cascode C calculation. Mixer - Performa and passive) – wo Oscillators - Pe coupled oscillator, Phase Locked Lo Drawbacks of sin Nonidealities (cor	I stagg FDR) itect iconv yne – ivers and t ce tra- ce tra- ce tra- fier - S sta fier - fier -	ges, Noise figu 	re of lossy circuits, Se I selection and band se am of image, image dyne and homodyne of t – Hartley & Weaven mitters. Unit –III – Quality factor, seri- apped inductor and ca barameters, Problem of active degeneration (Unit –IV xer noise figures, sing- reuits only) ters, Feedback view tors, (MOSFET circui- Unit –V pts - Phase detector, I PLLs - PFD, char-	ensitivity, dynamic ran selection, Heterodyne rejection vs channel with quadrature down r architecture. Transmi es to parallel conversi- pacitor networks of Input matching, CS s (MOSFET circuits of gle balanced and doub and one port view of ts only), Ring oscillato Type I PLL, Dynami	nge – conv itter a on, b tage f nly), le ba coscions. cs of mp I	spurious free nstant LO and ction, dual IF version, issues architectures 10 Hrs asic matching with inductive Noise figure 10 Hrs lanced (active illators, Cross 10 Hrs f simple PLL PLL, PFD/CF

CO1: Investigate the functionality of a typical RF system.

CO2: Analyze CMOS circuits and its impact on Radio frequency IC design.

CO3:	Design and implement RF transceiver chain with specification.
CO4:	Evaluate the different performance parameters used in RF design using CAD tools.

Refer	ence Books
1	Behzad Razavi, "RF Microelectronics", 2nd Edition Pearson Education, 2012
2	Thomas H Lee, "The Design of CMOS Radio Frequency Integrated Circuits",2nd Edition, Cambridge University Press, 2004
3	John Rogers ,Calvin Plett, "Radio Frequency Integrated Circuits Design", Artech House, 2003
4	Bosco Leung, "VLSI for Wireless Communications", Pearson Education, 2004

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12											
CO1	3	2	0	0	0	0	0	0	0	0	0	2
CO2	3	2	0	0	0	0	0	0	0	0	0	2
CO3	3	3	2	0	2	0	0	3	2	0	0	2
CO4	3	3	0	0	2	0	0	0	0	0	0	2

				Semester: VII					
			HIGH PER	FORMANCE CO	MPUTING				
(Group F: Professional Core Elective)									
(Theory)									
Cours	e Code	:	16EC7F5	()	CIE	:	100 Marks		
	ts: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks		
Total	Hours	:	50L		SEE Duration	:	03 Hours		
Course Learning Objectives: The students will be able to									
1 To review the trends in parallel programming.									
2 To demonstrate the basic ideas of multiprocessing and parallel operations with case studies.									
3 '	To expose to	bas	ics of parallel prog	gramming.					
4 ′	To demonstra	ite j	oarallel programm	ing using MPI, Op	enAcc and OpenMP.				
				Unit-I			10 Hrs		
Multi	processors a	nd '	Fhread level para	llelism:					
Introdu	uction, Symn	netr	ic shared memory	architectures; Per	formance of symmetr	ic sh	ared-memory		
-			ributed shared	•	irectory-based coher	ence	, Basics of		
synchr	onization, M	ode	ls of memory cons	•			I		
				J nit – II			10 Hrs		
				D, and GPU Arch					
					Extensions for Mul				
			cting and Enhancir	ig Loop-Level Para	allelism, Mobile versu	s Ser	ver GPUs and		
Tesla	versus Core i	7.							
				nit –III			10 Hrs		
			lel Programming						
					arallel Algorithm desi				
	•		•		eractions, Mapping Te		•		
Balanc	cing, Methods	5 10		unit –IV	Parallel Algorithms M	odels	3. 10 Hrs		
Due au							10 Hrs		
				e Passing Paradig	cks, MPI, Topologie	6 01	1 Embadding		
-		-		• •	tive Communication		•		
	~ ~		Communicators.	iiputatioli, Collect		anu	computation		
operati	ions, Groups	and		Unit –V			10 Hrs		
GPUI	Programmin	σп			rogramming using Op	enA			
					and Scaling, Parallel E				
					Resources. Pipelini				
				-	Generator, Pipelining	-			
Device	-	inti (duction to ripen	ling, Mundelorot	Selicitator, Tipenning	5 1 10	loss manpie		
Deriet									
Cours	e Outcomes:	Af	ter completing th	e course. the stud	ents will be able to				
CO1:									
CO1: Explore the fundamentals of high-performance computing concepts.CO2: Analyze the performance of parallel programming.									
CO3:				ructs for different a	applications.				
CO4:	U 1		· ·	concepts for suitab	**				
	ence Books		maner comparing	- sheep to for build					
Refer									
		n to	Parallel Computi	ng Ananth Grama	••	·ne V	arvnie Vinin		
Refere 1	Introduction		•	•	, Anshul Gupta, Geor J 13: <u>9788131708071</u> .	•	Carypis, Vipin		

2	CUDA Programming: A Developers Guide to Parallel Computing with GPUs, Shane Cook, 1 st Edition, 2013, Morgan Kaufmann, ISBN:9780124159334.
3	Parallel Programming with Open ACC, Rob Farber, 1 st Edition, 2016, Morgan Kaufmann (MK) Publication, ISBN :9780124103979.

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Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12											
CO1	3	2								1		1
CO2	3	2	2	1						1		1
CO3	3	3	2	2	2					1		1
CO4	3	3	3	3	2					1		1

	Semester: VII								
	INTEGRATED PHOTONICS								
	(Group F: Professional Core Elective)								
				(Theory)					
Cour	se Code	:	16EC7F6		CIE	:	100 Marks		
Cred	Credits: L:T:P:S : 4:0:0:0 SEE : 100 Marks								
Tota	Total Hours:50LSEE Duration:03 Hours								
Cour	rse Learning ()bj	ectives: The studen	ts will be able to					
1	Learn the fun	dan	nental principles of	photonics and light-	matter interactions				
2	Explain and i	llus	trate light guiding,	calculate wave propa	agation in waveguide	e sy	stems		
3	Calculate cha	ract	teristics of optical re	esonators					
4	4 Develop the ability to formulate problems related to photonic structures/processes and analyze								
	them								
3	 3 Calculate characteristics of optical resonators 4 Develop the ability to formulate problems related to photonic structures/processes and analyze 								

Unit-I	10 Hrs					
Introduction to EM theory: EM wave in dielectric media, Monochromatic EM waves, Absorption						
and Dispersion, Pulse propagation in Dispersive media, Polarization of light, Reflec	tion and					
Refraction, Optics in Anisotropic media.						
Unit – II	10 Hrs					
Photonic-crystal optics: Optics of Dielectric layered media, 1D & 2D Photonic crystals.						
Unit –III 10 Hrs						
Guided wave optics: Planar mirror waveguides, 2D waveguides, Photonic-Crystal waveguides, Photonic-Crys	veguides,					
Optical coupling in waveguides.						
Unit –IV	10 Hrs					
Resonator optics: Planar-Mirror Resonators, 2D & 3D resonators, Microresonators.						
Unit –V 10 Hrs						
Non-linear optics: Non-linear media, Second-order Non-linear optics, Third-order Non-linear optics.						

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Define and explain the propagation of light in conducting and non-conducting media.								
CO2:	Define and explain the physics governing laser behaviour and light matter interaction								
CO3:	Apply wave optics and diffraction theory to a range of problems								
CO4 :	Calculate properties of and design modern optical fibres and photonic crystals.								

Reference Books

1	B.E.A. Saleh, M.C. Teich, "Fundamentals of Photonics", Wiley India Pvt Ltd; 2 nd edition, 2012, ISBN: 9788126537747
2	A. Yariv and P. Yeh," Photonics - Optical Electronics in Modern Communications"; Oxford University Press, 6th Edition, ISBN: 0195179463
3	John D. Joannopoulos, Steven G. Johnson, Joshua N. Winn, and Robert D. Meade, "Photonic Crystals – Molding the Flow of Light", Princeton University Press; 2 nd Revised edition, 2013, ISBN-10: 0691124566
4	M. Jamal Deen and P.K. Basu, "Silicon Photonics - Fundamentals and Devices", John Wiley & Sons Ltd.,3rd Edition 2010,ISBN: 0-321-26977-2

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted

online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	-	-	-	-	-	1	-	1
CO4	3	3	3	3	-	-	-	-	-	1	-	1

	Semester: VII								
	NANOELECTRONICS								
	(Group F: Professional Core Elective)								
0	(Theory)								
	Course Code : 16EC7F7 CIE : 100 Marks								
	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks		
	l Hours	:	50L		SEE Duration	:	03 Hours		
Cou	Ŭ	~	ectives: The studen						
1	Develop sul nanoelectroni		intial understandi	ng of contempor	ary relevance and	d	potential of		
2	2 Develop appreciation of how factors like scaling and dimension lead to novel behaviour of nanoelectronic components;								
3			anding of the impo- henomena and device		deas and their place	in	modelling of		
4	*		•	c phenomena, nanoe	lectronic component	s ai	nd their		
	possible appli	cat	ions.						
			Ľ	Jnit-I			10 Hrs		
Revi	ew of Electron	ıs ()uantum mechanic	s: Electrons wave p	article duality, Wave	e eq	uation, Wave		
			-		Independent Schrö				
-				, The Harmonic Osc	-				
	v ,		•	nit – II			10 Hrs		
Free	and confined	el	ectrons: Free elect	rons, One-Dimensio	onal space, three-dir	nen	sional space,		
					antum Numbers, Pe				
			and Chemical poter				2		
			Un	nit –III			10 Hrs		
Part	Partially Confined Electrons: Finite Potential Wells, Parabolic well, triangular well, Electrons								

Partially Confined Electrons: Finite Potential Wells, Parabolic well, triangular well, Electrons Confined to Atoms, Quantum Dots, Wires, and Wells, Electrons in periodic potential, Kronig-Penney of Band structure

Unit –IV10 HrsTunnel junctions and applications of tunneling: Tunneling Through a Potential Barrier, Potential
Energy Profiles for Material Interfaces, Applications of Tunneling, Field Emission, Gate—Oxide
Tunneling and Hot Electron Effects in MOSFETs, Scanning Tunneling Microscope, Double Barrier
Tunneling and the Resonant Tunneling Diode

Unit –V10 HrsCoulomb blockade and the single-electron transistor: Tunnel Junction Excited by a CurrentSource, Coulomb Blockade in a Quantum Dot Circuit, The Single-Electron Transistor, Single-Electron Transistor Logic, Other SET and FET Structures, Carbon Nanotube Transistors (FETs andSETs), Semiconductor Nanowire FETs and SETs, Molecular SETs and Molecular Electronics

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Define novel behaviour of nanoelectronic devices and quantum behaviour of matter at the								
	nano scale & modelling of nanoelectronic devices.								
CO2:	Comprehend principles of devices such as tunneling diodes, single electron transistor,								
	spintronic devices.								
CO3:	Analysis fundamental concepts and methods of Analysis quantum tunneling, resonant								
	tunneling, Coulomb blockade, density of quantum states, quantum statistics and quantum								
	modelling.								

CO4:	Evaluate nano scale effects in	futuristic electron devices & c	quantum level computing
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Refer	ence Books
1	George W. Hanson, "Fundamentals of Nanoelectronics", Pearson, 1e, (2009), ISBN: 978- 8131726792
2	Charles P. Poole, Jr., Frank J. Owens, "Introduction to Nanotechnology", Wiley (15 January 2007), ISBN:978-8126510993
3	Rainer Waser, "Nanoelectronics and Information Technology", Wiley VCH; 3rd Revised edition edition(2012), ISBN: 978-3527409273
4	Chattopadhyay K.K, "Introduction to Nanoscience and Nanotechnology", PHI(2009), ISBN: 978-8120336087

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Semester End Evaluation (SEE); Theory (100 Marks)

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	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2				1	2					2
CO2	3	2	1			1	2					2
CO3	3	3	2		2	1	2					2
CO4	3	3	3	2	2	1	2					2

				Semester: VII								
	RADAR & NAVIGATION											
	(Group G: Professional Core Elective)											
(Theory)												
Course Code		:	16EC7G1		CIE	:	100 Marks					
Credits: L:T:P:S		:	4:0:0:0	SEE		:	100 Marks					
Total Hours		:	48L		SEE Duration	:	03 Hours					
Cou	rse Learning ()bj	ectives: The student	ts will be able to								
1	Understand th	ne t	asic operation of pu	lse and CW radar sys	stems.							
2	Evaluate the	rada	ar performance base	d on pulse width, pea	ak power and bean	n wic	lth.					
3	Choose suital	ole	tracking radar for a	given problem.								
4	Understand th	ne v	vorking of phased a	rray radars and navig	ational aids							

Unit-I	10 Hrs							
Radar and Radar Equation: Introduction, Radar block diagram and operation, frequencies,								
applications, types of displays, derivation of radar equation, minimum detectable signal, probability								
of false alarm and threshold detection, radar cross-section, system losses.								
Unit – II	10 Hrs							
CW Radar : Doppler Effect, CW Radar, applications, FM – CW radar, altimeter, Multiple Frequency								
Radar. Pulse Radar - MTI, Delay Line Canceller, Multiple Frequencies, Range-gated Doppl	er Filters,							
Non-coherent MTI, Pulse Doppler Radar								
Unit –III	10 Hrs							
Tracking Radar: Sequential lobing, conical scanning, monopulse, phase comparison me	onopulse,							
tracking in range, comparison of trackers.								
Unit –IV	09 Hrs							
Detection: Introduction, Matched Filter, Detection Criteria, Detector characteristics.								
Unit –V	09 Hrs							
Phased Arrays: Basic concepts, feeds, phase shifters, frequency scan arrays, multiple beams, applications, advantages and limitations. Navigational Aids: Direction Finder, VOR, ILS and Loran								

Course Outcomes: After completing the course, the students will be able to								
CO1:	Understand the basic operation of pulse and CW radar systems.							
CO2:	Evaluate the radar performance based on pulse width, peak power and beam width.							
CO3:	Choose suitable tracking radar for a given problem.							
CO4:	Select appropriate criterion for detecting a target.							

Refere	ence Books								
1	Williams. B. Ribbens, "Understanding Automotive Electronics", Elsevier science, 6th								
1	Edition, Newness publication, 2003, ISBN-9780080481494.								
2	Robert Bosch, "Automotive Electronics Handbook", John Wiley and Sons, 2004								
2	Nicolas Navet, F Simonot-Lion "Automotive Embedded Systems Handbook", Industrial								
3 Nicolas Navet, F Simonot-Lion "Automotive Embedded Systems Handbook", Indu Information Technology Series, CRC press.	Information Technology Series, CRC press.								
1	Uwekiencke and lars Nielsen, "Automotive Control Systems Engine, Driveline and vehicle",								
4	Springer, 2 nd Edition, 2005, ISBN 0-387-95368X								

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted

online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	
CO1	3	1	2	1	-	-	-	-	-	-	-	1	
CO2	3	2	2	1	-	1	-	-	-	-	-	1	
CO3	3	2	2	1	-	1	-	-	-	-	-	1	
CO4	3	1	2	1	-	1	-	-	-	-	-		

	Semester: VII											
	AUTOMOTIVE ELECTRONICS (Group G: Professional Core Elective)											
	(Theory)											
Cou	rse Code	:	16EC7G2		CIE	:	100 Marks					
Crec	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks					
Tota	Fotal Hours:48LSEE Duration:03 Hours					03 Hours						
Cou	rse Learning ()bj	ectives: The studen	ts will be able to								
1	Acquire the	kn	owledge of autom	otive domain fund	lamentals, need of	Ele	ectronics and					
	communicatio	on i	nterfaces in Automo	otive systems.								
2	Apply variou	s t	ypes of sensors, ac	ctuators and Motior	n Control technique	s ir	n Automotive					
	systems											
3	Understand d	ligi	tal engine control	systems and Embed	lded Software's and	$\frac{1}{E}$	CU's used in					
	automotive sy	vste	ms.									
4	Analyse the c	onc	cepts of Diagnostics	, safety and advance	es in Automotive ele	ctro	nic Systems.					

Unit-I	10 Hrs							
Fundamentals of Automotive: Use of Electronics in Automotive, Evolution of Electronics	ronics in							
Automotive, Automotive Systems, The Engine, Engine Control, Internal Combustion Engines, Spark								
Ignition Engines and Alternative Engines. Ignition System, Ignition Timing, Drivetrain, Suspensions,								
Brakes and Steering Systems, Demonstration of Four Cylinder manual transmission Engine.								
Basics of electronic engine control: Motivation for Electronic Engine Control – Exhaust En	missions,							
Fuel Economy, Concept of an Electronic Engine control system, Definition of Genera	al terms,							
Definition of Engine performance terms, Engine mapping, Effect of Air/Fuel ratio, spark tin	ning and							
EGR on performance, Control Strategy, Electronic Fuel control system, Analysis of intake	manifold							
pressure, Electronic Ignition.								
Unit – II	10 Hrs							
Automotive Sensors and Actuators:								
System Approach to Control and Instrumentation: Concept of A System, Analog and	l Digital							
Systems, Basic Measurement Systems, Analog and Digital Signal Processing, Automotive	e Control							
System Applications of Sensors and Actuators,								
Sensors: Air Flow Sensor, Engine Crankshaft Angular Position Sensor, Throttle Angle	Sensors: Air Flow Sensor, Engine Crankshaft Angular Position Sensor, Throttle Angle Sensor,							
Temperature Sensor, Sensors for Feedback Control, Sensors for Driver Assistance System	n: Radar,							
Lidar, Video Technology.								
Actuators: Solenoids, Piezo Electric Force Generators, Electric Motors and Switches.								
Unit –III	10 Hrs							
Digital Engine Control Systems: Digital Engine control features, Control modes for fuel								
(Seven Modes), EGR Control, Electronic Ignition Control - Closed Loop Ignition timin	<u> </u>							
Advance Correction Scheme, Integrated Engine Control System - Secondary Air Mana	0							
Evaporative Emissions Canister Purge, Automatic System Adjustment, System Diagnostics	5.							
Vehicle Motion Control: Typical Cruise Control System, Digital Cruise Control System	n, Digital							
Speed Sensor, Throttle Actuator, Digital Cruise Control configuration, Cruise Control El-	ectronics							
(Digital only), Antilock Brake System (ABS)								
Unit –IV	09 Hrs							
Automotive Communication Systems:								
Automotive networking: Bus systems, Technical principles, network topology. Buses	in motor							
vehicles: CAN, Flex Ray, LIN, Ethernet, IP, PSI5, MOST, D2B and DSI.								
Automotive Embedded Software Development								
Fundamentals of Software and software development lifecycles. Overview of AU								
methodology and principles of AUTOSAR Architecture. Use of MoTeC M800 ECU in	n engine							
management and data Acquisition Solutions.								
Unit –V	09 Hrs							

Diagnostics and Safety in Automotive:

Timing Light, Engine Analyzer, Electronic Control System Diagnostics: Onboard diagnostics, Offboard diagnostics, Expert Systems, Occupant Protection Systems – Accelerometer based Air Bag systems, Case study on ON-BOARD, OFF-BOARD diagnostics.

Advances in Automotive Electronic Systems: Alternative Fuel Engines, Electric and Hybrid vehicles, Fuel cell powered cars, Collision Avoidance Radar warning Systems, Navigation: Navigation Sensors, Radio Navigation, dead reckoning navigation, Video based driver assistance systems, Night vision Systems

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Acquire the knowledge of automotive domain fundamentals, need of Electronics and								
	communication interfaces in Automotive systems.								
CO2:	Apply various types of sensors, actuators and Motion Control techniques in Automotive								
	systems								
CO3:	Analyze digital engine control systems and Embedded Software's and ECU's used in								
	automotive systems.								
CO4:	Illustrate the concepts of Diagnostics, safety and advances in Automotive electronic								
	Systems.								

Refere	Reference Books									
1	Understanding Automotive Electronics, Williams. B. Ribbens, 6 th Edition, 2003, Elsevier science, Newness publication, ISBN-9780080481494.									
2	Automotive Electronics Handbook, Robert Bosch, 2004, John Wiley and Sons,									

Continuous Internal Evaluation (CIE); Theory (100 Marks)

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Semester End Evaluation (SEE); Theory (100 Marks)

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	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	0	0	0	1	2					2
CO2	3	2	1	0	0	1	2					2
CO3	3	3	2	0	2	1	2					2
CO4	3	3	3	2	2	1	2					2

Low-1 Medium-2 High-3

				Semester: VII							
MULTIMEDIA COMMUNICATION											
(Group G: Professional Core Elective)											
(Theory)											
Cou	rse Code	:	16EC7G3		CIE	:	100 Marks				
Credits: L:T:P:S : 4:0:0:0 SEE : 100 M						100 Marks					
Tota	Total Hours:48LSEE Duration:03 Hour										
Cou	rse Learning ()bj	ectives: The studen	nts will be able to							
1	Understand th	ne t	basics of analog and	l digital video: video	representation and t	ran	smission				
2	Analyze analo	og a	and digital video sig	gnals and systems							
3	Analyze the	fun	damental video pro	cessing techniques &	acquire the basic sl	kill	of designing				
	video compre	ssi	on	_							
4	Design video	tra	nsmission systems:	error control and rat	e control						

Unit-I	10 Hrs						
Multimedia Communications: multimedia information representation, multimedia networks,							
multimedia applications, network QoS and application QoS							
Unit – II	10 Hrs						
Text and image compression,, compression principles, text compression- Runlength, Huffm	an, LZW,						
Image compression- GIF, TIFF and JPEG.							
Unit –III	10 Hrs						
Audio and video compression: Introduction, audio compression, DPCM, ADPCM, APC, L	PC, video						
compression, video compression principles,							
Unit –IV	09 Hrs						
Video compression standards: H.261, H.263, MPEG, MPEG 1, MPEG 2, MPEG-4 and R	eversible						
VLCs,							
Unit –V	09 Hrs						
The Internet: Introduction, IP datagrams, fragmentation, Ip address, ARP and RARP, QoS.	Transport						
Protocol: Introduction, TCP/IP, TCP, UDP, RTP and RTCP.	-						

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Describe and describe various multimedia data.								
CO2:	Analyze the representation of multimedia data.								
CO3:	Describe the concept involved in MPEG4 standards.								
CO4:	Develop algorithms for protocols like RTP,RTCP for multimedia communication .over								
	mobile networks.								

Refere	ence Books								
1	Fred Halsall, "Multimedia Communications", Pearson education, 2001. ISBN: 8131709949,								
	978-8131709948								
2	K. R. Rao, Zoran S. Bojkovic, Dragorad A. Milovanovic, "Multimedia Communication Systems", Pearson education, 2004.ISBN: 013031398X978-0130313980								
3	Raif steinmetz, Klara Nahrstedt, "Multimedia: Computing, Communications and Applications", Pearson education, 2002,ISBN: 3540408673, 978-3540408673								
4	John Billamil, Louis Molina, "Multimedia : An Introduction", PHI, 2002, ISBN: 1575765578, 978-1575765570								

Continuous Internal Evaluation (CIE); Theory (100 Marks)

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Semester End Evaluation (SEE); Theory (100 Marks)

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	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	1	2	1	0	0	0					1
CO2	3	2	2	1	0	1	0					1
CO3	3	2	2	1	0	1	0					1
CO4	3	1	2	1	0	1	0					

Semester: VII											
			VLSI 7	TESTING FOR IC	CS						
(Group G: Professional Core Elective)											
				(Theory)							
Cou	rse Code	:	16EC7G4		CIE	:	100 Marks				
Cred	lits: L:T:P:S	:	4:0:0:0		SEE	:	100 Marks				
Total Hours:48LSEE Duration:03 Hours							03 Hours				
Cou	rse Learning ()bj	ectives: The student	s will be able to							
1	Understand d	iffe	rent types of faults a	ssociated with logi	c circuits and types	of te	esting by				
	employing fa	ult	models to the logic c	ircuits.							
2	Understand a	dva	nced methods of sim	ulation and digital	testing algorithms a	und u	ise the				
	appropriate m	neth	ods for achieving fa	ult coverage specif	ications in design.						
3	Explain the c	onc	epts Design for Tes	tability							
4	Recognize di	ffer	ent techniques in Bu	ilt In Self-Test (BI	ST) such as MBIST	and	LBIST.				
			•								
			U	nit-I			10 Hrs				

Unit-I	10 Hrs
Introduction to Testing- Introduction to Testing, Role of testing VLSI circuits, VLSI trend	ds
affecting testing, Faults in digital circuits.	
Fault Modeling- Functional Testing, Structural Testing, Types of Fault Models, Stuck-a	t Faults,
Bridging Faults, cross point faults, Fault Equivalence, Fault Dominance	
Unit – II	10 Hrs
Fault Simulation - Fault Simulation algorithm - Serial, Parallel, Deductive and Concurrent l	Fault
Simulation.	
Testability Measure - Controllability, Observability, SCOAP measures for combination	onal and
sequential circuits.	
Unit –III	10 Hrs
ATPG for Combinational Circuits- Path Sensitization Methods, Roth's D- Algorithm, Bo	olean
Difference, Complexity of Sequential ATPG, Time Frame Expansion.	
Design for Testability- Ad-hoc, Structured DFT- Scan method, Scan Design Rules, Over	heads of
Scan Design, partial scan methods, multiple chain scan methods.	
Unit –IV	09 Hrs
Self-test And Test Algorithms-Built-In self-Test, test pattern generation for BIST, response	se
compaction - Parity checking, Ones counting, Transition Count, Signature analyser (SISR a	ind
MISR).	
Circular BIST, BIST Architectures.	
Unit –V	09 Hrs
Memory Testing-Testable Memory Design Test Algorithms, Reduced Functional Faults-I	MARCH
and MAT+ algorithm. Test generation for Embedded RAMs. MBIST.	

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Attain knowledge about testing, fault modeling & collapsing.								
CO2:	Explore various fault simulation methods.								
CO3:	Evaluate the significance of combinational ATPG and sequential test pattern generation.								
CO4:	Get complete knowledge about different methods of LBIST and MBIST associated								
	with testing.								

Reference Books

1	L. T. Wang, C. W. Wu, and X. Wen, VLSI Test Principles and Architectures, Morgan Kaufmann, 2006, ISBN-13: 978-0-12-370597-6, ISBN-10: 0-12-370597-5.
2	Parag.K.Lala "Digital Circuit Testing and Testability" Academic Press.
3	M. L. Bushnell and V. D. Agrawal, <i>Essentials of Electronic Testing for Digital, Memory, and Mixed-Signal VLSI Circuits</i> , Kluwer Academic Publishers, 2000, ISBN: 0-7923-7991-8.
4	M. Abramovici, M. A. Breuer, and A. D. Friedman, Digital Systems Testing and Testable Design, Computer Science Press, 1990, ISBN: 0-7167-8179-4.

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	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5		PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	2	2	0	2	0	0			1		1
CO2	2	2	2	1	2	0	0			1		1
CO3	2	3	2	2	2	0	0			1		1
CO4	2	3	2	3	2	0	0			1		1

Low-1 Medium-2 High-3

Semester: VII HIGH SPEED DIGITAL DESIGN

(Group G: Professional Core Elective)

(Theory)

				(Theory)			
Course Code		:	16EC7G5	CIE	2	:	100 Marks
Cred	lits: L:T:P:S	:	4:0:0:0	SEH	Ξ		100 Marks
Total Hours		:	48L	SEF	E Duration	:	03 Hours
Cou	Course Learning Objectives: The students will be able to						
1	1 Understand analog circuit principles relevant to high speed digital design.						
2	Analyze pov	ver	distribution and noi	se in Power supply netwo	ork and signalin	ıg o	ver
	transmission lines.						
3	3 Demonstrate the functionality of different clocked and non clocked digital circuits and						
	memory elements.						
4	Analyze the r	berf	ormance of clocked	non clocked and latchin	g circuits		

Unit-I	10 Hrs			
The Interconnect: Introduction, Interconnect Modelling, Resistance, Capacitance, Inductance, Skin				
Effect, Temperature Dependence, Interconnect Impact: Delay, Energy, Crosstalk, Inductiv	e Effects,			
An Aside on Effective Resistance and Elmore Delay, Interconnect Engineering, Width, Spa	cing, and			
Layer, Repeaters, Crosstalk Control, Low-Swing Signalling, Regenerators, Logical Ef				
Wires.				
Unit – II	10 Hrs			

Introduction to high speed digital design: Frequency, time and distance issues in digital VLSI design. Capacitance and inductance effects, high speed properties of logic gates, speed and power. Modeling of wires, geometry and electrical properties of wires, Electrical models of wires, transmission lines, lossless LC transmission lines, lossy RLC transmission lines and special transmission lines.

Unit –III10 HrsPower distribution and Noise: Power supply network, local power regulation, IR drops, area
bonding. On-chip bypass capacitors and symbiotic bypass capacitors. Power supply isolation. Noise
sources in digital systems, power supply noise, crosstalk and inter symbol interference. Power
distribution on chips.

Unit –IV09 HrsClocked & non clocked Logics:Non clocked Logic Styles: Static CMOS, DCVS Logic, Non-
Clocked Pass Gate FamiliesClocked Logic Styles: Single-Rail Domino Logic, Dual-Rail Domino
StructuresJominoUnit –V09 Hrs

Electronics & Communication Engineering

Latching Strategies:Basic Latch Design, and Latching single-ended logic and Differential Logic, Race Free Latches for Pre-charged Logic Asynchronous Latch Techniques, DDR memories.

Course	Course Outcomes: After completing the course, the students will be able to						
CO1:	Investigate the special requirements that are imposed on high speed digital design.						
CO2:	Analyze the characteristics of transmission lines and high speed latches and circuits.						
CO3:	Analyze the Signaling convention in transmission media and high speed digital logics.						
CO4:	Evaluate the performance of various transmission lines and high speed digital circuits.						

Refere	Reference Books					
1	William S. Dally & John W. Poulton, "Digital Systems Engineering", Cambridge					
1	University Press, 1998. ISBN 0-521-59292-5					
2	Neil H. E. Weste David Money Harris, "CMOS VLSI Design: A Circuit and Systems					
4	Perspective" Pearson Publication, 4th Edition, 2011, ISBN 13: 978-0-321-54774-3					
	Kerry Bernstein, Keith M. Carrig, Christopher M. Durham, Patrick R. Hansen, David					
3	Hogenmiller, Edward J. Nowak, Norman J. Rohrer., "High Speed CMOS Design Styles",					
	Kluwer Academic Publishers in 1999, ISBN 978-1-4613-7549-4.					
1	Masakazu Shoji, "High Speed Digital Circuits", Addison Wesley Publishing Company,					
-	1996. ISBN 978-0201634839.					
5	Howard Johnson & Martin Graham, "High Speed Digital Design" A Handbook of Black					
5	Magic, Prentice Hall PTR, 1993.					
6	Jan M.Rabaey, Anantha Chadrakasan, Borivoje Nikolic, "Digital Integrated Circuits: A					
6	Design Perspective", (2/e), Pearson 2016, ISBN-13: 978-0130909961.					

Continuous Internal Evaluation (CIE); Theory (100 Marks)

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SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

					CO-1	PO Ma	pping					
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	0	0	0	1	2					2
CO2	3	2	1	0	0	1	2					2
CO3	3	3	2	0	2	1	2					2
CO4	3	3	3	2	2	1	2					2

Low-1 Medium-2 High-3

	Semester: VII								
	MEMS AND SMART SYSTEMS								
	(Group G: Professional Core Elective)								
	(Theory)								
Cou	rse Code	:	16EC7G6		CIE	:	100 Marks		
Cree	Credits: L:T:P:S : 4:0:0:0 SEE : 100 Mar					100 Marks			
Tota	Total Hours:48LSEE Duration:03 Hours								
Cou	rse Learning (Obj	ectives: The studen	ts will be able to					
1				dvanced micro- and	l smart systems.				
2				advanced micro- an					
3	Understand d	liffe	rent methods to fab	ricate MEMS devic	es.				
4	Present the ba	asic	s of implementatior	n of MEMS into pro	oducts				
				J nit-I			10 Hrs		
Intr	oduction to Mi	icro	and Smart System	s: Introduction, Mic	crosystem vs MEMS	S, Sn	nart Materials,		
struc	tures and syste	em,	Integrated Microsys	stems, Application of	of Smart Materials a	and N	Aicrosystems.		
Feyr	ıman's vision, l	Evo	lution of micro-man	ufacturing. Multi-di	isciplinary aspects. A	Appl	ications areas.		
Com	mercial produc	cts.							
					in rigid body dyn				
elect	rostatic forces,	sca	ling in electromagne	etic forces, scaling in	n electricity, scaling	in fl	uid dynamics.		
scali	ng effects in th	e oj	ptical domain, scalin	ng in biochemical pl	henomena.				
				nit — II			10 Hrs		
			ices and Systems:						
					systems. Sensors:				
					ilicon micro-mirror				
	• •				rmal actuator. portab	ble bl	lood analyzer,		
fiber	optic sensors,	Elec		ve, Microsystems at	Radio frequency.				
	• • • • •			nit –III		1	10 Hrs		
					ate materials, Si as a				
	Si compounds, Si Piezoresistors, Gallium Arsenide, Quartz, Piezoelectric Crystals and Polymers. Micro Manufacturing and Material Processing: Silicon wafer processing, Oxidation, CVD, PVD								
	, lithography, thin-film deposition, etching (wet and dry), wafer-bonding, and metallization, Silicon micromachining: surface, bulk , bonding based process flows.								
micr	omachining: su	irfa					00 11		
	Unit –IV 09 Hrs Electronics Circuits for Micro and Smart Systems: Electronic Amplifiers, Signal Conditioning								
Circ					heatstone Bridge, Pl				
A 1		Analog to Digital Conversion, Practical Signal Conditioning Circuits: Differential Charge							
	Measurement, Switched Capacitor circuits, Circuits for frequency measurement shifts.								
	surement, Swit	che			ency measurement sl	nifts.			
Mea			U	nit –V			09 Hrs		
Mea Elec	tronics, Circu	its :	U and Packaging: M	nit –V icro Systems Packa	ging, objectives and	l spe	09 Hrs		
Mea Elec micr	tronics, Circu o system packa	its : agin	U and Packaging: M g, Types of Micros	nit –V icro Systems Packa ystem Packages ,Pac		l spe ies	09 Hrs		

Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Describe main principles of MEMS and smart systems.					
CO2:	Demonstrate confidence in MEMS and smart systems through practical experience using					
	typical modern Computer Aided Design software for this task.					
CO3:	Apply a concept of a micro- and smart systems into a real device considering the scaling					
	laws and boundary conditions involved.					

CO4: Evaluate the principles and processes involved in the implementation of MEMS devices

Refere	nce Books
1	Tai-Ran Tsu, "MEMS & Microsystems: Design and Manufacture", Tata Mc-Graw-
	Hill.ISBN-13:9780070487093
2	K.J.Vinoy, G.K.Ananthasuresh, S.Gopalakrishnan, K.N.Bhat, "Micro and Smart
	Systems", Wiley India, ISBN: 9788126527151
2	S. D. Senturia, "Microsystems Design", Kluwer Academic Publishers, Boston, USA, 2001,
3	ISBN 0-7923-7246-8.
	Minhang Bao, "Analysis and Design Principles of MEMS Devices", Elsevier,
4	Amsterdam, Netherlands, ISBN 0-444-51616-6.

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	3	2	3	2	0	1			0		1
CO2	0	0	2	0	2	1	1		2	0		1
CO3	3	1	2	3	2	1	1	1	1	1		1
CO4	1	3	3	3	2	1	1	1	1	1		1

Low-1 Medium-2 High-3

				Semester: VII				
	IMAGE PROCESSING AND MACHINE LEARNING							
(Group H: Global Elective)								
Cou	rse Code	:	16G7H05		CIE	:	100 Marks	
Cre	dits: L:T:P:S	:	3:0:0:0 SEE : 100 Marks			100 Marks		
	Total Hours:40LSEE Duration:03 Hours							
Course Learning Objectives: The students will be able to								
1 Understand the major concepts and techniques in image processing and Machine Learning								
2			1	image processing te				
3	To become fa	mil	iar with regression	methods, classificati	ion methods, cluster	ing	methods.	
4			e 1 e	Machine Learning ki	nowledge by design	ing a	and	
	implementing	g alg	gorithms to solve pr	ractical problems				
							r	
				Unit-I			08 Hrs	
	oduction to im	~	- 0					
-		-		d DPI, Bitmap imag		-	-	
		, C	olor spaces, Bezie	r curve, Ellipsoid, (Gamma correction,	Adv	vanced image	
concepts								
Unit – II 08 Hrs								
	•			nit – II			08 Hrs	
	ics of Python &		cikit image:					
Basi	cs of python,	vari	cikit image: ables & data types	, data structures, co			al statements,	
Basi uplo	cs of python, vading & view	vari	cikit image: ables & data types				al statements,	
Basi uplo	cs of python,	vari	c ikit image: ables & data types an image, Image	s, data structures, co e resolution, gamm			al statements, ing structural	
Basi uplo simi	cs of python, v ading & view larities.	vari 'ing	c ikit image: ables & data types an image, Image U	s, data structures, co e resolution, gamm nit –III			al statements,	
Basi uplo simi Adv	cs of python, v ading & view larities. anced Image p	vari ving	cikit image: ables & data types an image, Image Ui cessing using Oper	s, data structures, co e resolution, gamm nit –III n CV	a correction, deter	mini	al statements, ing structural 08 Hrs	
Basi uplo simi Adv Bler	cs of python, v ading & view larities. anced Image p ading Two Imag	vari ving oro o ges,	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast	s, data structures, co e resolution, gamm nit –III n CV and Brightness Addi	a correction, deter	mini Smoo	al statements, ing structural 08 Hrs othing Images	
Basi uplo simi Adv Bler , Me	cs of python, v ading & view larities. anced Image p ading Two Imag edian Filter, Ga	vari ving Droo ges, uuss	cikit image: ables & data types an image, Image Us cessing using Oper Changing Contrast ian Filter ,Bilatera	s, data structures, co e resolution, gamm nit –III n CV and Brightness Addi l Filter ,Changing th	a correction, deter ing Text to Images S a Shape of Images	mini Smoo	al statements, ing structural 08 Hrs othing Images	
Basi uplo simi Adv Bler , Me	cs of python, v ading & view larities. anced Image p ading Two Imag edian Filter, Ga	vari ving Droo ges, uuss	cikit image: ables & data types an image, Image U cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Per	s, data structures, co e resolution, gamm nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E	a correction, deter ing Text to Images S a Shape of Images	mini Smoo	al statements, ing structural 08 Hrs othing Images fecting Image	
Basi uplo simi Adv Bler , Me Thre	cs of python, y ading & view larities. Fanced Image p ading Two Imag edian Filter ,Ga esholding ,Calcu	vari ring oroo ges, iuss ulat	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Perf	s, data structures, co e resolution, gamm nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV	a correction, deter ing Text to Images S a Shape of Images	mini Smoo	al statements, ing structural 08 Hrs othing Images	
Basi uplo simi Adv Bler , Me Three Mac	cs of python, v ading & view larities. anced Image p ading Two Imag edian Filter ,Ga esholding ,Calco chine Learning	vari ving oroo ges, ulat g Te	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Pert U: cchniques in Image	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing	a correction, deter ing Text to Images S ne Shape of Images Equalization	smoo ,Efi	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs	
Basi uplo simi Adv Bler , Me Three Baye	cs of python, v ading & view larities. anced Image p ading Two Imag edian Filter ,Ga esholding ,Calcu chine Learning esian Classifica	vari ing oroo ges, ulat g Te	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Pert U: cchniques in Image n, Maximum Likeli	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur	a correction, deter ing Text to Images S he Shape of Images Equalization al Networks; Non-p	smoo ,Efi	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs	
Basi uplo simi Adv Bler , Me Three Baye	cs of python, v ading & view larities. anced Image p ading Two Imag edian Filter ,Ga esholding ,Calcu chine Learning esian Classifica	vari ing oroo ges, ulat g Te	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Perf U: cchniques in Image n, Maximum Likelil upport Vector Mac	s, data structures, co e resolution, gamm nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur- hines, Logistic Regre	a correction, deter ing Text to Images S he Shape of Images Equalization al Networks; Non-p	smoo ,Efi	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models;	
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Basi uplo simi Adv Bler , Me Three Bayo Man Intr Exha	cs of python, v ading & view larities. anced Image p ading Two Image edian Filter ,Ga esholding ,Calcu chine Learning esian Classifica ifold estimation oduction to ob austive vs. Stoc	vari ing proo ges, ulat g Te tion n, S jec chas	cikit image: ables & data types an image, Image Uf cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Perf Uf cchniques in Image n, Maximum Likelil upport Vector Mac U t Tracking , Mode stic Search, Shapes,	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur- hines, Logistic Regre init –V ling & Recognition	a correction, deter ing Text to Images S the Shape of Images Equalization al Networks; Non-p ession earance Models. Mo	mini Smoo , ,Efi aaran	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models; 08 Hrs shift tracking;	
Basi uplo simi Adv Bler , Me Thre Mac Bayo Man Intr Exha Con	cs of python, v ading & view larities. anced Image p ading Two Image edian Filter ,Ga esholding ,Calco chine Learning esian Classifica ifold estimation oduction to ob austive vs. Stoc tour-based mod	vari ing proo ges, ulat g Te tion n, S jec chas lels	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Pert U: cchniques in Image h, Maximum Likelil upport Vector Mac U t Tracking , Mode stic Search, Shapes, , Adaboost approac	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur- hines, Logistic Regre vint –V ling & Recognition , Contours, and Appo- hes: Face Detection A	a correction, deter ing Text to Images S as Shape of Images Equalization al Networks; Non-p ession earance Models. Ma / Recognition, Trac	mini Smoo , ,Efi aaran	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models; 08 Hrs shift tracking;	
Basi uplo simi Adv Bler , Me Three Bayo Man Intr Exha Con	cs of python, v ading & view larities. anced Image p ading Two Image edian Filter ,Ga esholding ,Calco chine Learning esian Classifica ifold estimation oduction to ob austive vs. Stoc tour-based mod	vari ing proo ges, ulat tion n, S jec chas lels. : Af	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Perf U: cchniques in Image n, Maximum Likelil upport Vector Mac U t Tracking , Mode stic Search, Shapes, , Adaboost approac	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur- hines, Logistic Regre init –V ling & Recognition , Contours, and Appe hes: Face Detection	a correction, deter ing Text to Images S he Shape of Images Equalization al Networks; Non-p ession earance Models. Mo / Recognition, Trac ts will be able to	mini Smoo , ,Efi aaran	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models; 08 Hrs shift tracking;	
Basi uplo simi Adv Bler , Me Thre Bay Man Intr Exha Con Cou	cs of python, v ading & view larities. anced Image p ading Two Image edian Filter ,Ga esholding ,Calcu chine Learning esian Classifica ifold estimation oduction to ob austive vs. Stoc tour-based mod	vari ing proo ges, ulat g Te gtion n, S lels i Af ledg	cikit image: ables & data types an image, Image United States cessing using Oper Changing Contrast ian Filter ,Bilaterat ing Gradients , Perf United States n, Maximum Likelit upport Vector Mac Ut Tracking , Mode stic Search, Shapes, Adaboost approac Citer completing the ge about basic conc	s, data structures, co e resolution, gamma nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neura hines, Logistic Regro Unit –V ling & Recognition , Contours, and Appo hes: Face Detection a e course, the studen epts of Image Proces	a correction, deter ing Text to Images S be Shape of Images Equalization al Networks; Non-p ession earance Models. Mo / Recognition, Trac ts will be able to ssing	mini Smoo , ,Efi aaran	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models; 08 Hrs shift tracking;	
Basi uplo simi Adv Bler , Me Three Bayo Man Intr Exha Con	cs of python, v ading & view larities. anced Image p ading Two Image edian Filter ,Ga esholding ,Calcu chine Learning esian Classifica ifold estimation oduction to ob austive vs. Stoc tour-based mod rse Outcomess I: Gain know 2: Identify ma	variing proo ges, ulat g Te ttior n, S jec chas lels i Af ledg achi	cikit image: ables & data types an image, Image U: cessing using Oper Changing Contrast ian Filter ,Bilatera ing Gradients , Perf U: chniques in Image h, Maximum Likelil upport Vector Mac U t Tracking , Mode stic Search, Shapes, Adaboost approac Citer completing the ge about basic conc ne learning techniq	s, data structures, co e resolution, gamme nit –III n CV and Brightness Addi l Filter ,Changing th forming Histogram E nit –IV e Processing hood Methods, Neur- hines, Logistic Regre init –V ling & Recognition , Contours, and Appe hes: Face Detection	a correction, deter ing Text to Images S be Shape of Images Equalization al Networks; Non-p ession earance Models. Mo / Recognition, Trac ts will be able to ssing /en problem	mini Smoo , ,Efi aaran	al statements, ing structural 08 Hrs othing Images fecting Image 08 Hrs netric models; 08 Hrs shift tracking;	

CO3: Write programs for specific applications in image processing

CO4: Apply different techniques for various applications using machine learning techniques.

Reference Books 1 Practical Machine Learning and Image Processing: For Facial Recognition, Object Detection, and Pattern Recognition Using Python, Himanshu Singh, 1st Edition, Apress, ISBN:978-1-4842-4149-3

2	Pattern Recognition and Machine Learning, Christopher Bishop, 1 st Edition, Springer, 2008, ISBN: 978-0387-31073-2
3	Computer Vision: A modern Approach, David Forsyth and Jean Ponce, 2 nd Edition, Prentice Hall India 2004, ISBN: 978-0136085928
4	Machine Vision: Theory Algorithms Practicalities, E.R. Davies, 2 nd Edition, Elsevier, ISBN: 978-0-12-386908-1.
5.	Digital Image Processing, Rafael C. Gonzalez and Richard E. Woods Pearson Education, 3 rd Edition, ISBN 978-81-317-2695-2.

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 60 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. **Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks**.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	VIII Semester		
	Major Project		
Cour	se Code: 16ECP81		CIE Marks: 100
Cred	its: L: T: P: S:: 0:0:16:0		SEE Marks: 100
Hrs/v	week: 32		SEE Duration: 3 Hrs
Course Learning Objectives: The students will be able to			
1	Acquire the ability to make links across different areas of knowledge and to generate, develop and		
	evaluate ideas and information so as to apply these skills to the project task.		
2	Acquire the skills to communicate effectively and to present ideas clearly and coherently to a specific		
	audience in both written and oral forms.		
3	3 Acquire collaborative skills through working in a team to achieve common goals.		
4	Self-learn, reflect on their learning and take appropriate action to improve it.		
5	Prepare schedules and budge	ets and keep track of the pro-	ogress and expenditure.

Major Project Guidelines:

The project topic, title and synopsis have to be finalized and submitted to their respective internal guide(s) before the beginning of the 8th semester.

The detailed Synopsis (approved by the department **Project Review Committee**) has to be submitted during the 1st week after the commencement of 8th semester.

Batch Formation:

- Students are free to choose their project partners from within the programme or any other programme.
- Each student in the team must contribute towards the successful completion of the project. The project may be carried out In-house / Industry / R & D Institution.
- The project work is to be carried out by a team of two to four students, in exceptional cases where a student is placed in a company and offered an internship through the competitive process or student is selected for internship at national or international level through competitive process, the student can work independently.
- The students are allowed to do either a project for full 5 days in the industry or full 5 days in the college.
- In case the project work is carried out outside Bengaluru, such students must be available during Project Evaluation process scheduled by the respective departments and they must also interact with their guide regularly through Email / Webinar / Skype etc.

Project Topic Selection:

The topics of the project work must be in the *field of respective program areas or in line with CoE's(Centre of Excellence) identified by the college* or List of project areas as given by industry/Faculty. The projects as far as possible should have societal relevance with focus on sustainability.

Project Evaluation:

- Continuous monitoring of project work will be carried out and cumulative evaluation will be done.
- The students are required to meet their internal guides once in a week to report their progress in project work.
- Weekly Activity Report (WAR) has to be maintained in the form of a diary by the project batch and the same has to be discussed with the Internal Guide regularly.
- In case of *Industry project*, during the course of project work, the internal guides will have continuous interaction with external guides and will visit the industry at least twice during the project period.
- For CIE assessment the project groups must give a final seminar with the draft copy of the project report.
- The presentation by each group will be for 20-30 minutes and every member of the team needs to justify the contributions to the project.
- The project team is required to submit Hard copies of the detailed Project Report in the prescribed format to the department.
- ➢ For CIE 50% weightage should be given to the project guide and 50% weightage to the project evaluation committee.
- Before the final evaluations the project group is required to produce a No dues certificate from Industry, Central Library and Department.

Cour	se Outcomes of Major Project:	
1	Apply knowledge of mathematics, science and engineering to solve respective engineering domain problems.	
2	Design, develop, present and document innovative/multidisciplinary modules for a complete engineering system.	
3	Use modern engineering tools, software and equipment to solve problem and engage in life-long learning to follow technological developments.	
4	Function effectively as an individual, or leader in diverse teams, with the understanding of professional ethics and responsibilities.	

CIE Assessment:

The following are the weightings given for the various stages of the project.

		1 5	
1.	Selection of the topic and formulation of objectives		10%
2.	Design and Development of Project methodology		25%
3.	Execution of Project		25%
4.	Presentation, Demonstration and Results Discussion		30%
5.	Report Writing & Publication		10%
SEE A	ssessment:		
The	e following are the weightages given during Viva Examination.		
1.	Written presentation of synopsis	10%	
2.	Presentation/Demonstration of the project		30%
3.	Methodology and Experimental Results & Discussion	30%	
4.	Report		10%
5.	Viva Voce		20%

VIII Semester			
	Technical Seminar		
Course Code: 16ECS82 CIE Marks: 50		CIE Marks: 50	
Credits: L: T: P: S:: 0:0:2:0 SEE Marks: 00		SEE Marks: 00	
Hrs/	Irs/week: 4 SEE Duration: NA		
Course Learning Objectives: The students will be able to			
1	Recognize recent developments in specific program and in multidisciplinary fields.		
2	Summarize the recent technologies and inculcate the skills for literature survey.		
3	Demonstrate good presentation skills.		
4	Plan and improve the Technical Report writing skills.		
5	Support Group discussion and Team work.		

General Guidelines for the Seminar

- 1. The seminar has to be presented by individual student.
- 2. The topic of the seminar should be from current thrust area along with consultation with the guide.
- 3. The topic can be based on standard papers (like IEEE/ACM/CSI etc.) in the thrust area for the selected topic.
- 4. Presenting/publishing this paper in conference/ Journal will be given weightage in CIE.
- 5. The student needs to submit both hard & soft copy of the seminar report.
- 6. As Outcome of Technical Seminar, each student has to prepare a technical paper out of seminar topic.

Cour	Course Outcomes of Technical Seminar:		
1	Communicate effectively on complex engineering problems and demonstrate contextual knowledge		
	to assess societal and environmental contexts.		
2	Identify, formulate, review research literature, analyze and Design solutions for complex		
	engineering problems using appropriate techniques with effective documentation.		
3	Analyze, interpret and synthesize the information to provide valid conclusions with innovative ideas		
	and ethical principles.		
4	Apply the knowledge of engineering specialization to suggest solutions to complex engineering		
	problems and recognize the need for technological changes.		

Evaluation of CIE Marks:

1.	Relevance of the topic	10%	
2.	Literature Survey		10%
3.	Presentation		40%
4.	Report		20%

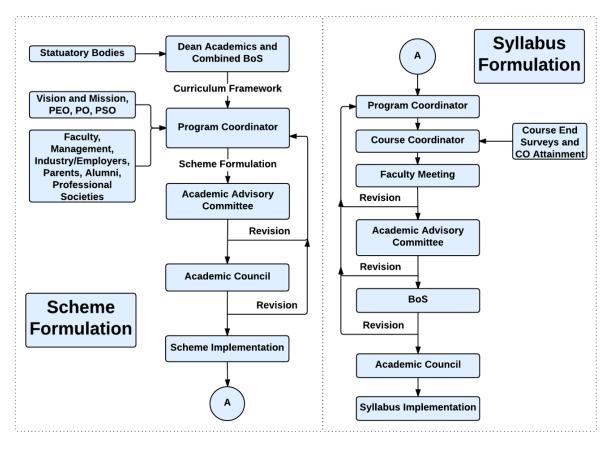
5. Paper Publication 20%

	VIII Semester		
	Innovation & Social Skills		
Cour	Course Code: 16HSS83 CIE Marks: NA		
Cred	lits: L: T: P: S:: 0:0:1:0		SEE Marks: NA
Hrs/	week: 2		SEE Duration: NA
Course Learning Objectives: The students will be able to			
1	1 To provide a platform for the students to exhibit their organizational capabilities, team building, ethical values and extra mural abilities.		
2	2 To encourage to carryout innovative ideas and projects.		
3	Take part in societal and com	munity building activities.	
4	Make self-learning, ethics and	d lifelong learning a motto.	

Guidelines

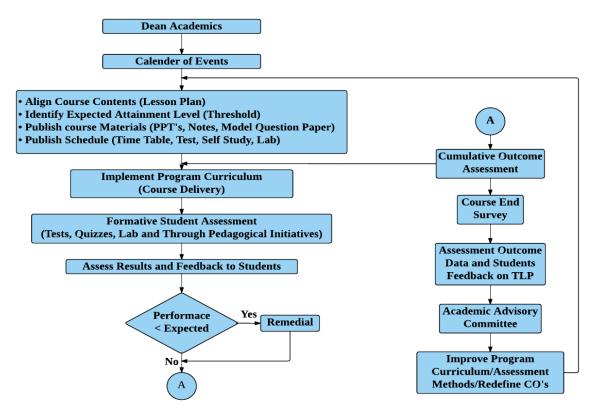
- 1. The HSS will be evaluated individually based on the broad parameters which include the progress made by student during 3rd& 4th year in innovative projects, Seminar, Paper Presentation, Field activity & other Co-curricular activities.
- 2. Students shall submit a report and documents as a proof his/her achievements.

Course Outcomes of Innovation & Social Skills:		
1	Apply the knowledge and skills for solving societal issues	
2	Plan to work in team in various areas with inclusive effort and sustainability	
3	Organize various events and use managerial and budgeting abilities	
4	Demonstrate leadership qualities and ethics	

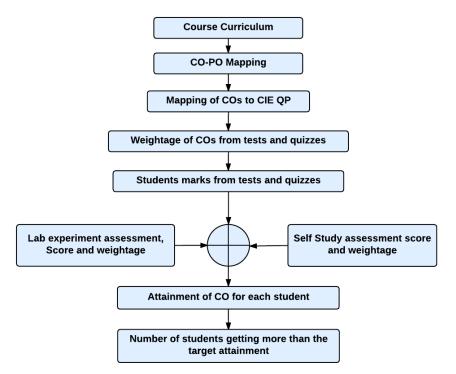


Curriculum Design Process

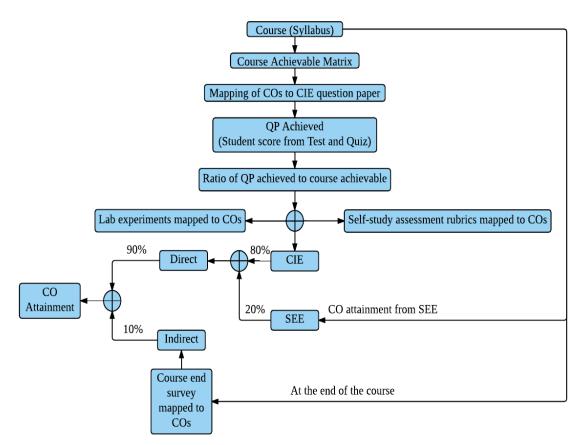
Academic Planning and Implementation



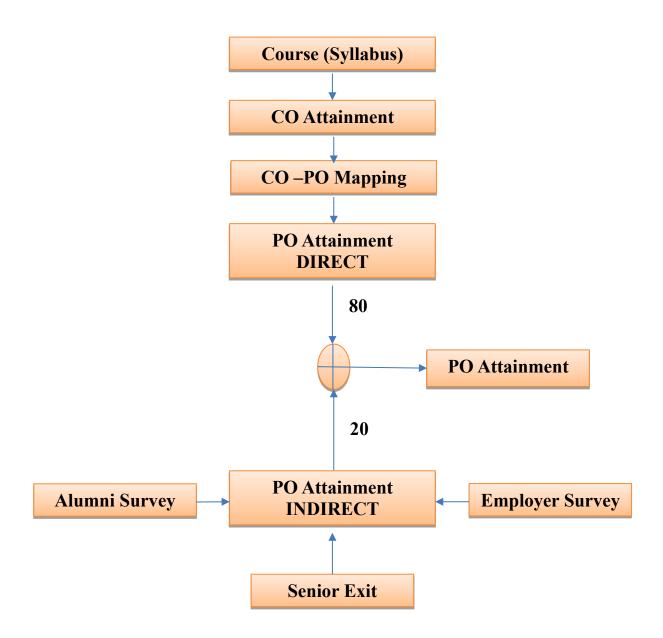
PROCESS FOR COURSE OUTCOME ATTAINMENT



Final CO Attainment Process



Program Outcome Attainment Process



Guidelines for Fixing Targets

• The target may be fixed based on last 3 years' average attainment

PROGRAM OUTCOMES (POs)

1. **Engineering knowledge:** Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialisation for the solution of complex engineering problems.

2. **Problem analysis:** Identify, formulate, research literature, and analyse complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.

3. **Design/development of solutions:** Design solutions for complex engineering problems and design system components or processes that meet t h e specified needs with appropriate consideration for public health and safety, and cultural, societal, and environmental considerations.

4. **Conduct investigations of complex problems:** Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions.

5. **Modern tool usage**: Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools, including prediction and modelling to complex engineering activities, with an understanding of the limitations.

6. **The engineer and society:** Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal, and cultural issues and the consequent responsibilities relevant to the professional engineering practice.

7. Environment and sustainability: Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.

8. **Ethics:** Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.

9. **Individual and team work:** Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.

10. **Communication:** Communicate effectively on complex engineering activities with the engineering community and with t h e society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.

11. **Project management and finance:** Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments.

12. Life-long learning: Recognise the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.